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# **NH<sub>4</sub>V<sub>4</sub>O<sub>10</sub> nanobelts vertically grown on 3D TiN nanotube arrays as high-performance electrode materials of supercapacitors**

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High performance supercapacitor without binders has attracted wide attention as an energy storage device. In this work, novel NH<sub>4</sub>V<sub>4</sub>O<sub>10</sub> nanobelts were successfully synthesized and decorated into TiN nanotube arrays by a simple hydrothermal method. The as-prepared no-binder electrode hybrids exhibited excellent electrochemical performances with a specific capacitance of 749.0 F g<sup>-1</sup> at 5 mV s<sup>-1</sup> and a capacity retention of 85.7% after 200 cycles, which makes it an appealing candidate for electrode materials of supercapacitors.

## 1. Introduction

An urgent need to address energy shortage problems is caused by the contradiction between the increasing demand of human society for energy and the decreasing storage of non-renewable fossil resources. Thus, the research on the storage and application of sustainable energy has become a hot topic recently. Among numerous energy storage devices, supercapacitors (SCs) have captured significant attention because of their high power density, ultra-rapid charge-discharge rate, long cycle life, great stability and low maintenance cost.<sup>1-4</sup>

Traditional electrodes like carbon electrodes have a lot of disadvantages including poor cycle stability and low charge efficiency.<sup>5</sup> Thus, it is essential to develop innovative electrodes for advanced supercapacitors. The highly ordered nanostructured materials (such as nanotube, nanopore, and nanofiber) can provide a definite architecture with ordered alignment to improve electrochemical performance. In recent years, many researchers have carried out extensive research on TiN nanotube arrays as electrode material for supercapacitors. Wang *et al.* developed a simple template-free method of preparing mesoporous TiN nanostructures directly on Ti foils. The TiN nanosheets had a capacitance of 81.63 F g<sup>-1</sup> at the current density of 0.5 A g<sup>-1</sup>. Additionally, it showed great cycle stability. The capacitance retention is still 100% after 2500 cycles.<sup>6</sup> Xie *et al.* prepared TiN nanoarrays by a nitridation process of titania in an ammonia atmosphere. The specific capacitance of TiN nanopore array reached an extraordinarily high level up to 99.7 mF cm<sup>-2</sup>.<sup>7</sup>

Among various electrode materials, vanadium layered oxides have received much attention due to the various oxidation states of vanadium(v) and the multiple kinds of coordination

polyhedral.<sup>8-10</sup> Layered ammonium vanadium oxides have larger layer spacing than V<sub>2</sub>O<sub>5</sub>, which can enable the insertion/extraction of guest ions without significant damage to the host structure.<sup>11-13</sup> The research on NH<sub>4</sub>V<sub>4</sub>O<sub>10</sub> to date has been focused on the electrochemistry performance in monovalent-ion batteries.<sup>14-19</sup> For examples, Zhang *et al.* synthesized NH<sub>4</sub>V<sub>4</sub>O<sub>10</sub> nanobelts as a cathode material of Li-ion battery with the first discharge capacity of 171.8 mA h g<sup>-1</sup>.<sup>17</sup> Huang *et al.* synthesized (NH<sub>4</sub>)<sub>0.5</sub>V<sub>2</sub>O<sub>5</sub> nanobelts as a cathode material of Li-ion battery with an initial specific discharge capacity of 225.2 mA h g<sup>-1</sup> and a capacity retention rate of 79.9% after 40 cycles.<sup>18</sup> Chen *et al.* prepared NH<sub>4</sub>V<sub>4</sub>O<sub>10</sub> micro-flowers as cathode for MLIBs with a specific discharge capacity of 228 mA h g<sup>-1</sup> at 100 mA g<sup>-1</sup>.<sup>19</sup> According to our best knowledge, however, NH<sub>4</sub>V<sub>4</sub>O<sub>10</sub> hasn't been reported as electrode materials of supercapacitors due to its poor conductivity.

In this work, lawn-like NH<sub>4</sub>V<sub>4</sub>O<sub>10</sub> was decorated into 3D TiN nanotube arrays as electrode materials of supercapacitors, which combined the high specific capacitance of NH<sub>4</sub>V<sub>4</sub>O<sub>10</sub> and excellent electrical conductivity, chemical stability and special surface area of TiN NTAs. The composition and morphology are measured by using XRD, SEM and EDS. The electrochemical performances of all samples in a electrolyte containing K<sup>+</sup> are measured and discussed.

## 2. Experimental section

### 2.1 Preparation of NH<sub>4</sub>V<sub>4</sub>O<sub>10</sub>/TiN nanotube arrays

**Preparation of TiN nanotube arrays (NTAs).** All chemicals were used as received without further purification. TiN NTAs were prepared by annealing TiO<sub>2</sub> nanotube arrays in ammonia.<sup>20,21</sup> TiO<sub>2</sub> nanotube arrays were first synthesized by the anodization of a 20 × 22 mm Ti mesh substrate (>99.5%) in a self-made two-electrode cell containing a Ti counter electrode.<sup>22-24</sup> The anodization was performed at 60 V in a solution

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of 2 vol% HF in diethylene glycol (analytically pure) at room temperature for 24 h. The as-prepared  $\text{TiO}_2$  NTAs were further rinsed in ethyl alcohol and then dried in air for use. Subsequently,  $\text{TiO}_2$  NTAs were annealed in a tubular furnace at 750 °C in ammonia for 4 h with a progressive heating ramp (room temperature to 300 °C, 2 °C min<sup>-1</sup>; 300 to 750 °C, 5 °C min<sup>-1</sup>).

**Preparation of  $\text{NH}_4\text{V}_4\text{O}_{10}$ /TiN NTAs.** In the hydrothermal procedure, 1 mmol  $\text{NH}_4\text{VO}_3$  and 1.2 mmol  $\text{H}_2\text{C}_2\text{O}_4 \cdot 2\text{H}_2\text{O}$  were initially dissolved in 20 mL deionized water with magnetic stirring for 15 min. The mixed solution and TiN NTAs were subsequently transferred to a Teflon-sealed stainless-steel autoclave. Afterwards, the autoclave was placed into a baking oven for hydrothermal treatment at 180 °C for 8 h, 12 h and 16 h, respectively. After cooling down to room temperature, these samples were taken out, washed with deionized water and dried at 60 °C for 10 h. According to the time of hydrothermal deposition, these samples were denoted as TNV-8, TNV-12 and TNV-16, respectively. The reference sample prepared by depositing  $\text{NH}_4\text{V}_4\text{O}_{10}$  into Ti mesh by hydrothermal treatment at 180 °C for 12 h was marked as TV-12, where the precipitates of hydrothermal reaction were collected by centrifugation at 8000 rpm, subsequently washed with ethanol and dried in air at 60 °C for 10 h. The precipitates were denoted as NVO.

## 2.2 Material characterization

X-ray diffraction (XRD) patterns were recorded by using a Rigaku D/Max 2550VB3+/PC X-ray diffractometer with Cu K $\alpha$  radiation ( $\lambda = 0.15406$  nm). X-ray photoelectron spectroscopy (XPS) data were obtained from a Kratos AXIS ULTRA electron spectrometer with Mg K $\alpha$  X ( $h\nu = 1486.6$  eV, 900 nm of beam spot) as the incident radiation source, and the detected binding energy was calibrated by carbon (C 1s = 284.6 eV). Morphological and lattice structural information was obtained from field emission scanning electron microscopy (FESEM, Nova Nano SEM 450) and high-resolution transmission electron microscopy (TEM, JEOL 2010F).

## 2.3 Electrochemical characterization

Electrochemical measurement was carried out with CHI660E electrochemical three-electrode system in 2 M KCl solution, where the samples acted as the working electrode, Pt foil acted as the counter electrode, and Ag/AgCl electrode acted as the reference electrode. Cyclic voltammetry (CV) curves were recorded in a voltage range from 0.2 V to 0.8 V at different scan rates of 5, 10, 20, 40, 60, 80 and 100 mV s<sup>-1</sup>, respectively. Galvanostatic charge/discharge curves were recorded in a potential window from -0.2 to 0.8 V at a series of current densities. The electrochemical impedance spectroscopy (EIS) was conducted in the frequency from 100 kHz to 10 mHz at an open-circuit potential of 5 mV.

## 3. Results

Fig. 1 gives XRD patterns of TiN, NVO, TNV-8, TNV-12 and TNV-16. All diffraction peaks from NVO are well indexed to monoclinic  $\text{NH}_4\text{V}_4\text{O}_{10}$  (JCPDS no. 31-0075).<sup>13,15</sup> The crystal structure of

$\text{NH}_4\text{V}_4\text{O}_{10}$  shown in Fig. 1b is an assembly of double layers made up of distorted octahedra and trigonal bipyramids of V–O polyhedral stacking along the c-axis of the unit cell and encapsulating ammonium ions. The strong (001) peak located at 8.6° indicates a larger interlayer spacing (10.4 Å) of the as-synthesized NVO than that of  $\text{NH}_4\text{V}_4\text{O}_{10}$  crystal (9.6 Å), which benefits ion diffusion and structural stabilization for enduring prolonged electrochemical cycles. There are no other diffraction peaks in NVO, indicating that a pure single-phase  $\text{NH}_4\text{V}_4\text{O}_{10}$  is obtained. The peaks in the XRD patterns of TNV-8, TNV-12 and TNV-16 are associated with  $\text{NH}_4\text{V}_4\text{O}_{10}$  besides the diffraction peaks of Ti and TiN.

Fig. 2 gives XPS spectra of TNV-12 to further confirm the formation of  $\text{NH}_4\text{V}_4\text{O}_{10}$ . It reveals that TNV-12 consists of elements V, O, N and C. The binding energy (BE) of C 1s is 284.8 eV, which is the standard binding energy for calibration instrument. V 2p high-resolution spectrum illustrates the mixed

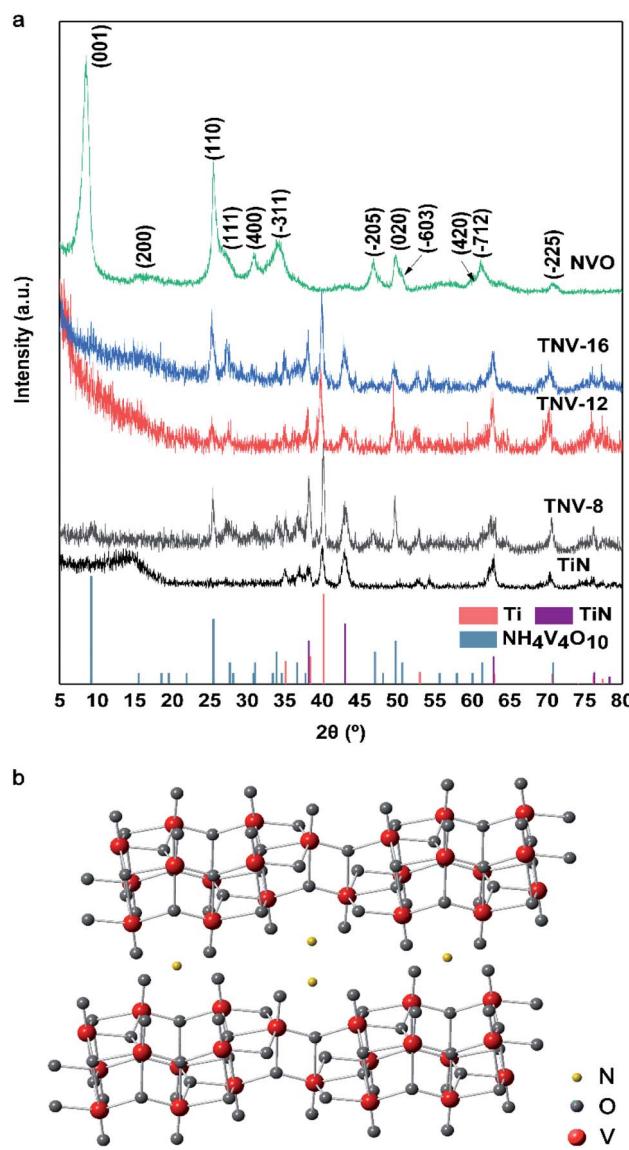


Fig. 1 (a) XRD patterns of different samples and (b) crystal structure of  $\text{NH}_4\text{V}_4\text{O}_{10}$  (TNV-8, TNV-12 and TNV-16).



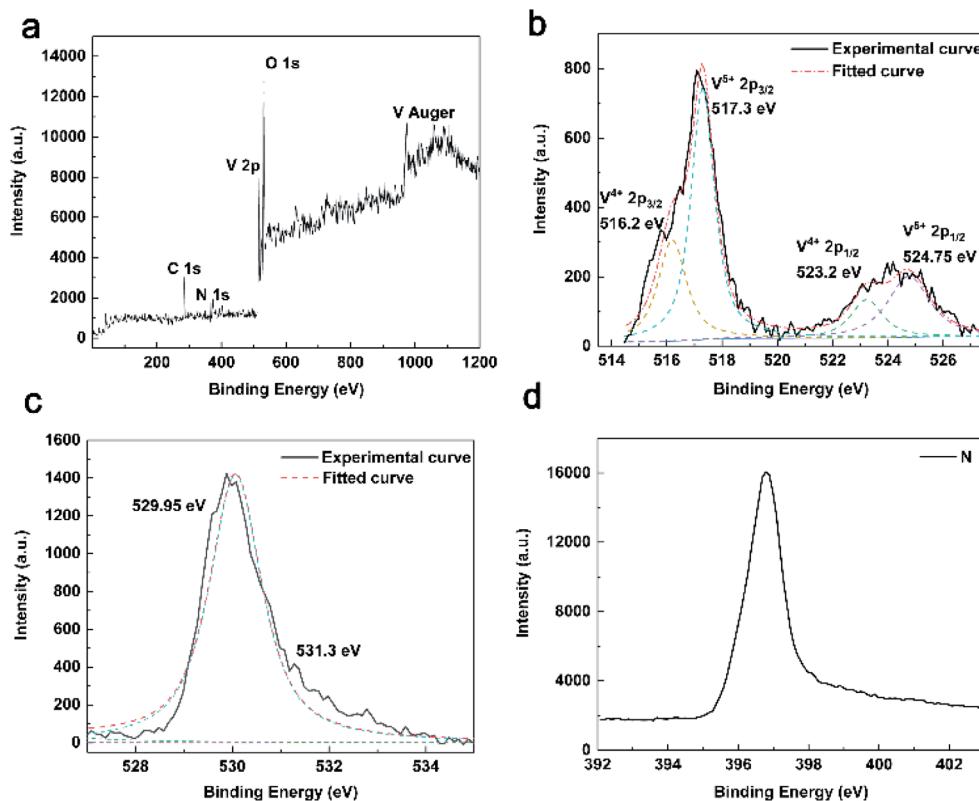


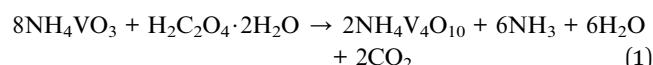
Fig. 2 (a) XPS survey spectrum of TNV-12 and high resolution XPS spectra of V 2p (b), O 1s (c) and N 1s (d).

valence state of V shown in Fig. 2b. The peaks at 517.3 and 524.75 eV are corresponding to the  $2p_{3/2}$  and  $2p_{1/2}$  of  $V^{5+}$ . The peaks at 516.2 eV and 523.2 eV are corresponding to the  $2p_{3/2}$  and  $2p_{1/2}$  of  $V^{4+}$ , respectively. The BEs at 529.95 eV and 531.3 eV in Fig. 2c are associated with  $O-V^{5+}$  and  $O-V^{4+}$ , respectively,<sup>25,26</sup> further demonstrating the mixed valance state of V in  $NH_4V_4O_{10}$ . Fig. 2d displays single N 1s core level spectrum, further indicating the presence of  $NH_4^+$ .<sup>27</sup>

Fig. 3 shows TEM images of NVO sample, indicating that the  $NH_4V_4O_{10}$  has a belt-like structure with a width of about 100 nm. The lattice spacing of 0.577 nm in Fig. 3b originates from (111) lattice plane of  $NH_4V_4O_{10}$ . Fast Fourier transform analysis shown in Fig. 3c further reveals that NVO has a monoclinic  $NH_4V_4O_{10}$  crystal structure.

Fig. 4 shows the SEM images of TNV-8, TNV-12 and TNV-16. It can be clearly observed that the morphology of  $NH_4V_4O_{10}$  changes from nanobelts to nanosheets with the increase of the hydrothermal reaction time as shown in Fig. 4d-f. They vertically grew on the surface of the TiN nanotube array.

The hydrothermal reaction for the formation of  $NH_4V_4O_{10}$  is as follows:



The CV curves of all samples except TiN display four pairs of asymmetric redox peaks and the details are shown in Fig. 5a. Fig. 5b indicates that TNV-12 has the highest specific

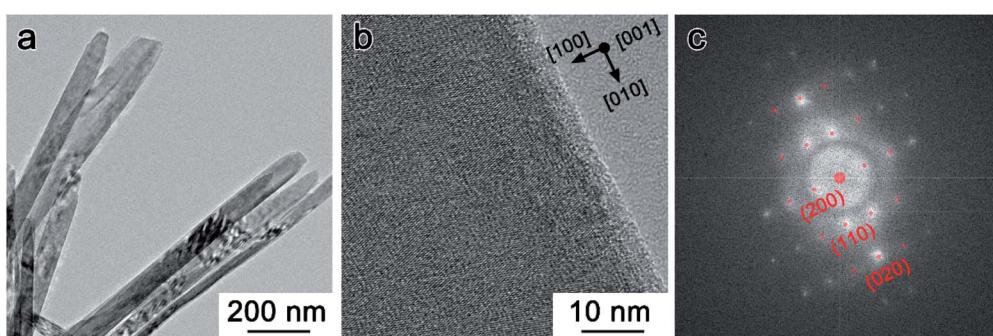


Fig. 3 (a) TEM and (b) HRTEM images of NVO sample; (c) the corresponding FFT image.



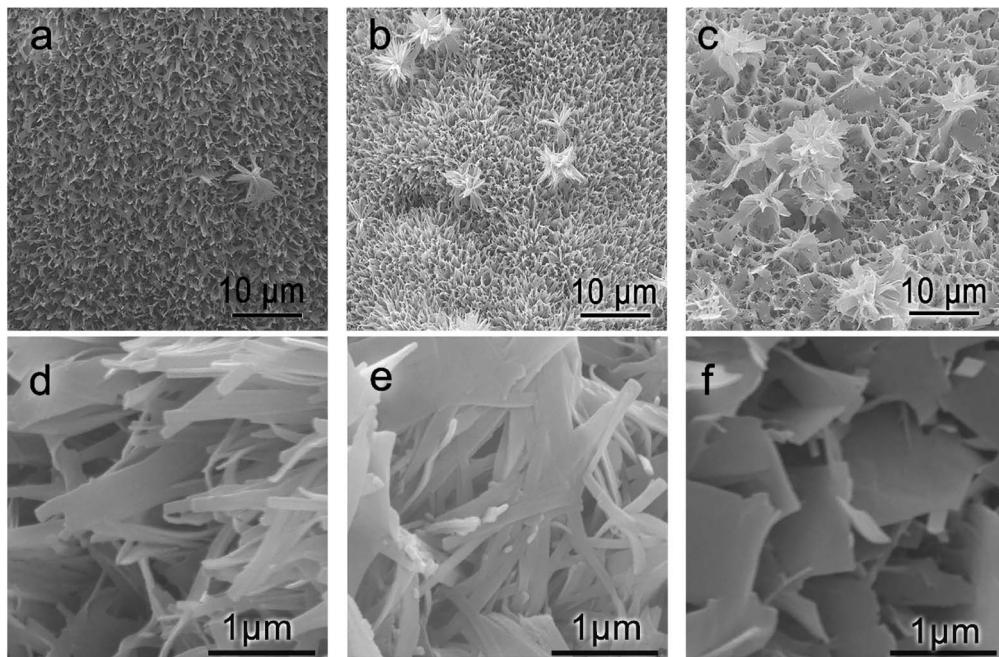


Fig. 4 SEM images of sample TNV-8 (a and d), sample TNV-12 (b and e) and sample TNV-16 (c and f).

capacitance of  $749.0 \text{ F g}^{-1}$  at  $5 \text{ mV s}^{-1}$ , which is 85.9% higher than that of TV-12. Fig. 5c and d display the galvanostatic charge–discharge (GCD) curves and the corresponding specific capacitance of TiN, TV-12, TNV-8, TNV-12 and TNV-16 samples at a current density of  $4 \text{ A g}^{-1}$ . All GCD curves exhibit the near

triangle shapes, presenting a reversible and fast ion doping/dedoping property. TNV-12 shows the highest specific capacitance of  $197.4 \text{ F g}^{-1}$  at  $4 \text{ A g}^{-1}$ , which is nearly three times that of TV-12. Moreover, the redox peaks of TNV-12 are more obvious than those of TV-12. All results indicate that TiN NTAs can not

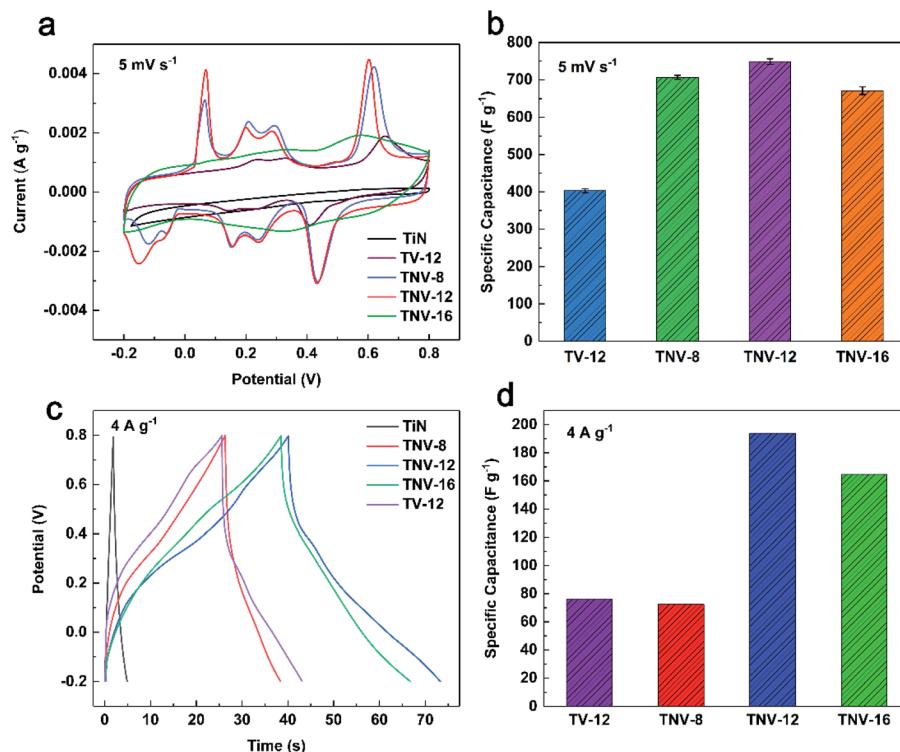


Fig. 5 (a) Cyclic voltammetry curves of TiN, TV-12, TNV-8, TNV-12 and TNV-16 under the sweep speed of  $5 \text{ mV s}^{-1}$ ; (b) specific capacitance of different samples under the sweep speed of  $5 \text{ mV s}^{-1}$ ; (c) charging–discharge curves of TiN, TV-12, TNV-8, TNV-12 and TNV-16 at  $4 \text{ A g}^{-1}$ ; (d) specific capacitance of different samples at  $4 \text{ A g}^{-1}$ .

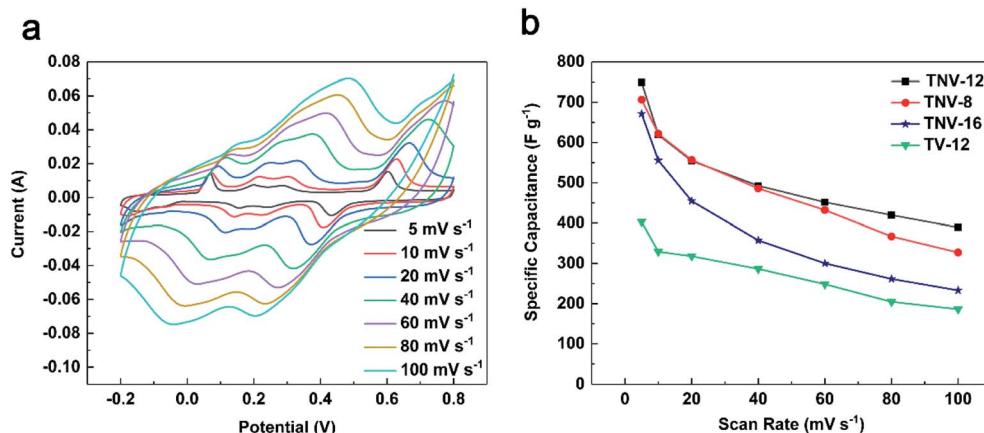


Fig. 6 (a) Cyclic voltammetry curves of TNV-12 at different scan rates; (b) specific capacitance of TV-12, TNV-8, TNV-12 and TNV-16 at different scan rates.

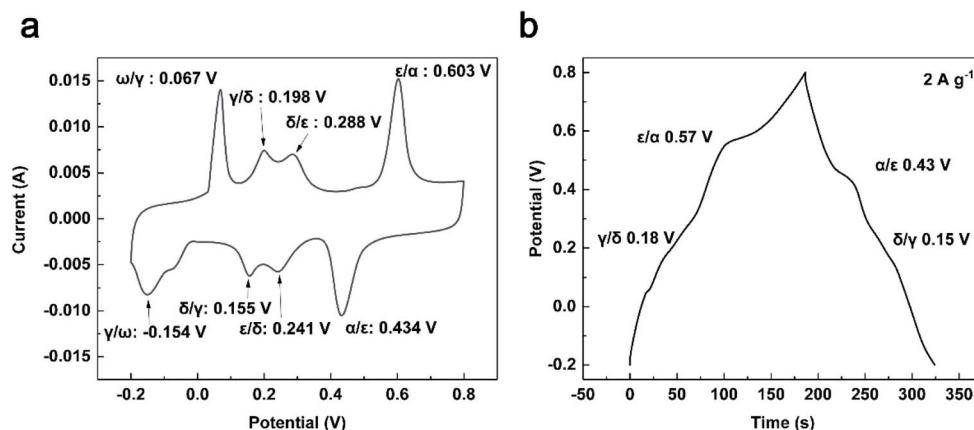


Fig. 7 (a) Cyclic voltammetry curve of TNV-12 at 5 mV s<sup>-1</sup>; (b) charging–discharge curve of TNV-12 at 2 A g<sup>-1</sup>.

only provide high speed path for electrons, but also dramatically enlarge the specific surface area of electrode for contacting with electrolyte, which can markedly shorten transport distances of electrolytic ions. This excellent electrical conductivity of TiN is also confirmed by the results of electrochemical impedance spectroscopy (EIS) shown in Fig. 8a.

Fig. 6a displays the CV curves of TNV-12 at a series of scan rates from 5 to 100 mV s<sup>-1</sup>. The curves have similar shapes and peaks, and the currents gradually increase with increasing scan rates. As shown in Fig. 6b, the specific capacitance shares the opposite changing trend against the scan rates. TNV-12 exhibits the highest specific capacitance among these samples at the

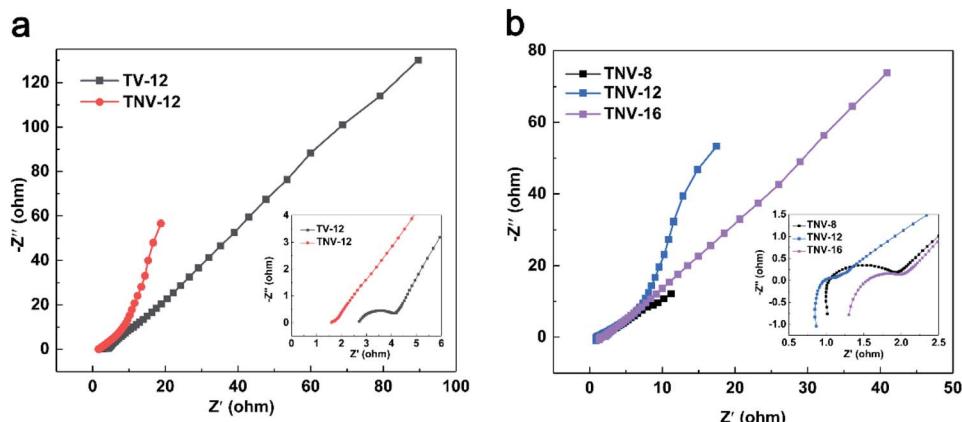


Fig. 8 Nyquist plot of (a) TV-12 and TNV-12; (b) TNV-8, TNV-12 and TNV-16.



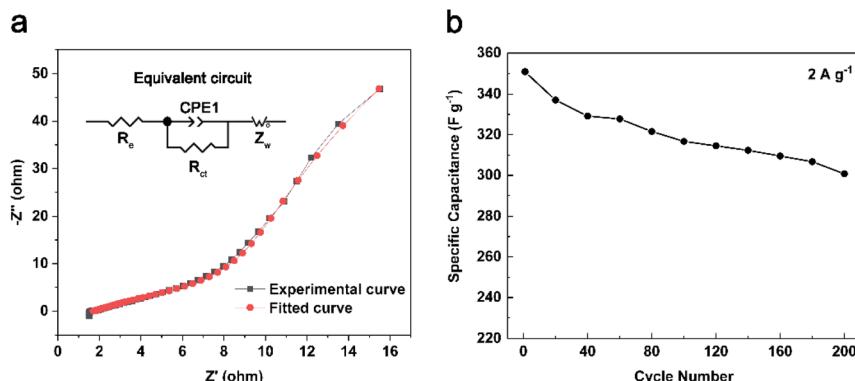


Fig. 9 (a) Nyquist plot and fitting curve of TNV-12, the inset is equivalent circuit; (b) the relation between specific capacitance of TNV-12 and cycle-index at  $2 A g^{-1}$ .

given scan rate, especially  $749.0 F g^{-1}$  at  $5 mV s^{-1}$  and  $389.4 F g^{-1}$  at  $100 mV s^{-1}$ , indicating that TNV-12 possesses high rate performance.

Fig. 7 gives the detailed CV and GCD curves of TNV-12 at  $5 mV s^{-1}$  and  $2 A g^{-1}$ , respectively. It can be clearly observed that there are four cathodic peaks located at  $-0.154$ ,  $0.155$ ,  $0.241$  and  $0.434$  V, and these four peaks correspond to the  $\gamma/\omega$ ,  $\delta/\gamma$ ,  $\varepsilon/\delta$ ,  $\alpha/\varepsilon$  phase transitions within the potential range from  $0.2$  V to  $0.8$  V (vs.  $Ag^+/Ag$ ). The four anodic peaks at  $0.067$ ,  $0.198$ ,  $0.288$  and  $0.603$  V can be ascribed to the reverse phase transitions of  $\omega/\gamma$ ,  $\gamma/\delta$ ,  $\delta/\varepsilon$  and  $\varepsilon/\alpha$ .<sup>28-30</sup> The redox peaks of  $NH_4V_4O_{10}$  electrode material in KCl can be ascribed to the intercalation/deintercalation of  $K^+$  ions into/from  $NH_4V_4O_{10}$  lattice. In Fig. 7b, there are several peaks located at  $0.18$ ,  $0.57$ ,  $0.43$  and  $0.15$  V, which are similar to the potential of  $\gamma/\delta$ ,  $\varepsilon/\alpha$ ,  $\alpha/\varepsilon$  and  $\delta/\gamma$  phase transitions in Fig. 6a, respectively. Ion-intercalated electrode materials normally involve the phase transitions. During charge/discharge process, chemical reactions occur at distinct potential where one phase is converted to another. Thus the peaks on GCD curves are associated with reversible phase transitions under particular voltage.<sup>16</sup> These phenomena indicate the apparent pseudocapacitance characteristics of TNV-12.

Fig. 8 gives the Nyquist plot of TV-12, TNV-8, TNV-12 and TNV-16 measured in the frequency range from  $100$  kHz to

0.1 Hz. The Nyquist plot is divided into two parts: an arc at higher frequency region and a slash at lower frequency region. In Fig. 8a, TNV-12 electrode yields a smaller semicircle in the high-frequency region and a greater slope in the low-frequency region than TV-12 electrode, indicating a lower charge transfer impedance and a superior ion diffusion due to its enlarged specific surface area. In Fig. 8b, the intercept at real part ( $Z'$ ) represents a combination ( $R_e$ ) of the ionic resistance of the electrolyte. The intrinsic resistance of the substrate and the contact resistance between the active material and the current collector interface indicate that TNV-8, TNV-12 and TNV-16 have the similar  $R_e$  values. The semicircle in the high-frequency range corresponds to the charge-transfer resistance ( $R_{ct}$ ) caused by the faradaic reactions. The slope of the curve called the Warburg resistance ( $Z_w$ ) is a result of the frequency dependence of ion diffusion/transport in the electrolyte to the electrode surface. According to the simulation circuit shown in Fig. 9a, the calculated  $R_e$  and  $R_{ct}$  are  $1.31 \Omega$  and  $269.3 \Omega$  for TNV-8,  $1.69 \Omega$  and  $864.3 \Omega$  for TNV-12, and  $1.87 \Omega$  and  $528.8 \Omega$  for TNV-16, respectively. Therefore TNV-12 has the lowest  $R_e$ ,  $R_{ct}$  and  $Z_w$  among the three samples.

Fig. 9b shows the cycling stability of the TNV-12 composite electrode material at a current density of  $2 A g^{-1}$  for 200 cycles. After 200 cycles, the specific capacitance of TNV-12 decreased

Table 1 Capacitance and cycle stability of materials with similar characteristics

Electrode	Capacitance	Cycle stability	Ref.
$NH_4V_4O_{10}$ nanobelts on TiN nanotube arrays	$749.0 F g^{-1}$ at the scan rate of $5 mV s^{-1}$ and $197.4 F g^{-1}$ at the current density of $4 A g^{-1}$	The capacitance retention is 85.7% after 200 cycles	This work
TiN nanosheet arrays on Ti foils	$81.63 F g^{-1}$ at the current density of $0.5 A g^{-1}$	The capacitance retention is 75% after 4000 cycles	6
TiN/VN composites with core/shell structure	$170 F g^{-1}$ at $2 mV s^{-1}$	The capacitance retention is 89% after 500 cycles	31
$\beta-Na_{0.33}V_2O_5$ nanobelt	$320 F g^{-1}$ at $5 mV s^{-1}$	The capacitance retention is 66% after 4000 cycles	32
TiN-VN core-shell structure	$247.5 F g^{-1}$ at $2 mV s^{-1}$	The capacitance retention is 88% after 500 cycles	33
3D $MnO_2/TiN$ NTAs on Ti mesh	$550 F g^{-1}$ at the scan rate of $5 mV s^{-1}$	The capacitance retention is 83.77% after 600 cycles	20



from 350.9 to 300.7 F g<sup>-1</sup> with a retention rate of 85.7%. At the same time, the mass of TNV-12 dropped by 53% because soluble ions in aqueous solution such as H<sub>2</sub>VO<sub>4</sub><sup>-</sup> and HVO<sub>4</sub><sup>2-</sup> were delivered from NH<sub>4</sub>V<sub>4</sub>O<sub>10</sub> during the continuous Galvanostatic charge/discharge process.

As shown in Table 1, we compare the material in this paper with other materials with similar characteristics.

As we can see from the table, compared with materials with similar characteristics, our material has higher specific capacitance. In the meanwhile, it also shows good cycle stability.

## 4. Conclusions

Novel NH<sub>4</sub>V<sub>4</sub>O<sub>10</sub> nanobelts were successfully synthesized and decorated into TiN nanotube arrays by a simple hydrothermal method. The as-prepared NH<sub>4</sub>V<sub>4</sub>O<sub>10</sub> has layered structure with a large interlayer spacing of 5.7 Å and nanobelt morphology. The composite electrode material presents specific capacities of 749.0 F g<sup>-1</sup> at the scan rate of 5 mV s<sup>-1</sup> and 197.4 F g<sup>-1</sup> at the current density of 4 A g<sup>-1</sup>. It exhibits good cycling stability with a retaining rate of 85.7% at 2 A g<sup>-1</sup> after 200 cycles. According to the results of our research, NH<sub>4</sub>V<sub>4</sub>O<sub>10</sub>/TiN NTAs composite is a promising electrode material for SCs.

## Conflicts of interest

There are no conflicts to declare.

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